

SANYO Semiconductors DATA SHEET

LB1801CL — Monolithic Digital IC Stepping Motor Driver IC

Overview

The LB1801CL is a 2-channel low-saturation drive low-voltage operation forward/reverse motor driver IC. Its ultraminiature package makes it optimal for 2-phase excitation drive of 2-phase bipolar stepping motors which are commonly used in various portable devices such as digital still cameras.

Features

- Low saturation voltage, V_O (sat) = 0.3V typ. at IO of 150mA
- Built-in through current prevention circuit
- Zero current drawn in standby mode
- On-chip index comparator (open collector output)
- On-chip ENA interlocked power supply
- Built-in thermal shutdown circuit
- ECSP2828-12 ultraminiature leadless package (2.8mm×2.8mm×0.8mm typ)

Parameter	Symbol	Conditions	Ratings	Unit
Maximum power supply voltage	V _{CC} max		-0.3 to +8.0	V
Output application voltage	V _{OUT} max	OUT1, OUT2, OUT3, OUT4 pin	V _{CC} +VSF	V
Input application voltage	V _{IN} max	ENA, IN1, IN2 pin	-0.3 to +8.0	V
GND pin outflow current	I GND	Per channel	300	mA
Allowable power dissipation	Pd max	Mounted on a circuit board *	450	mW
Operating temperature	Topr		-30 to +75	°C
Storage temperature	Tstg		-40 to +150	°C

Absolute Maximum Ratings at $Ta = 25^{\circ}C$

* Mounted on a specified board: 20.0mm×10.0mm×0.8mm, paper phenol

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LB1801CL

Allowable Operating Range at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
Power supply voltage	V _{CC}		2.2 to 7.5	V
Input high level voltage	VIH	ENA, IN1, IN2 pin	1.5 to 7.5	V
Input low level voltage	VIL		-0.3 to +0.3	V
Allowable comparator output current	ICOMP		1.0	mA

Electrical Characteristics at Ta = 25 °C, $V_{CC} = 3.3V$

Parameter	Curren ol	Conditions					
Parameter	Symbol	Conditions	min	typ	max	unit	
Power source current	ICC0	ENA = 0V, V_{IN} = 3V or 0V		0.1	1	μA	
	I _{CC} 1	ENA = 3V, V_{IN} = 3V or 0V		17	18.5	mA	
Output saturation voltage	VOUT ¹	ENA = 3V, V _{IN} = 3V or 0V, I _{OUT} = 100mA		0.23	0.3		
	V _{OUT} 2	ENA = 3V, V _{IN} = 3V or 0V, I _{OUT} = 200mA *		0.5		V	
Input current	IIN	V _{IN} = 3V		60	70	μA	
	IENA	V _{ENA} = 3V		60	70		
Index comparator		·			·		
Internal reference voltage	VINP		1.30	1.35	1.40	V	
Common-mode input voltage range	VCOM		0		V _{CC}	V	
Input hysteresis width	VHYS1		0.15	0.22	0.25	V	
Low-level output voltage	VLCOMP	Sink = 1mA		0.2	0.4	V	
LNA interlocked power supply	•						
Current capacity	IBIAS	$\Delta (V_{IN}-VBIAS) = 0.2V$	50			mA	
Spark killer diode	•	-					
Reverse current	IS(leak)				1	μA	
Forward voltage	VSF	I _{OUT} = 200mA *		1.7		V	
Thermal shutdown	-		<u> </u>		·		
Operating temperature	TSD1	*		170		°C	
Hysteresis width	TSD2	*		20		°C	

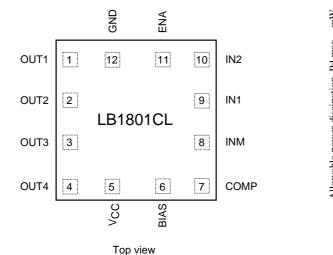
*: Design target value and no measurement was made.

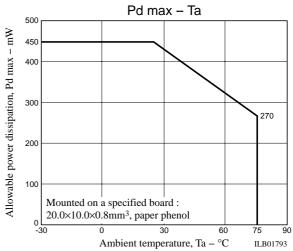
Package Dimensions

unit : mm (typ) 3324

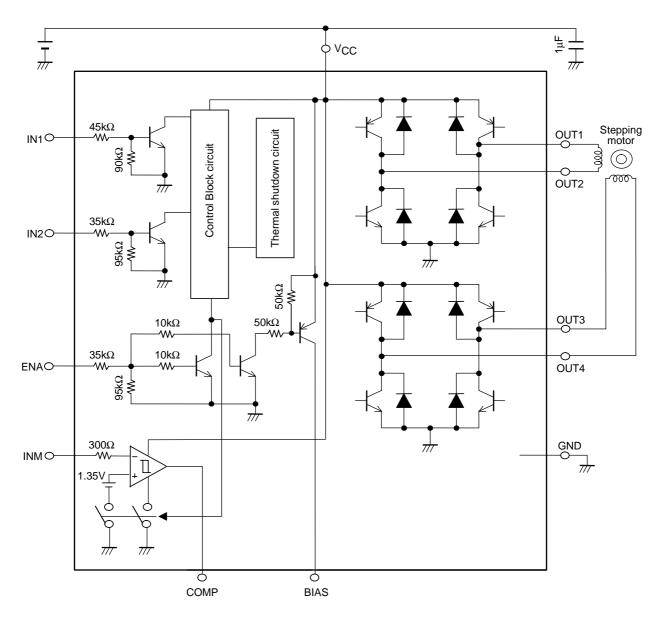
TOP VIEW SIDE VIEW BOTTOM VIEW (0.425)2.8 0.4 0.35 ~ 2.8 0.65 0.8 SIDE VIEW (0.8) 0.8 0.015 SANYO : ECSP2828-12

Pin Assignment





Block Diagram



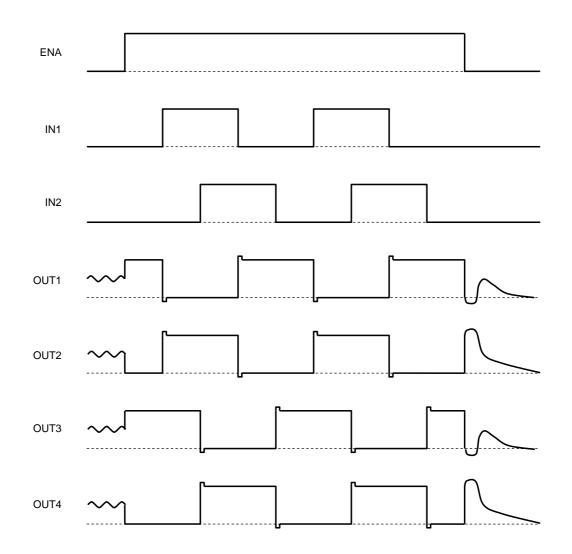
Truth Table

	Input Output				Input			Remarks				
ENA	IN1	IN2	OUT1	OUT2	OUT3	OUT4	BIAS	COMP	Remarks			
L	-	-	OFF	OFF	OFF	OFF	OFF	OFF	Standby			
	L	L	Н	L	Н	L	ON		2 phase			
	L	н	Н	L	L	н						
Н	н	н	L	н	L	н		ON	ON	ON ON	excitation	excitation
	Н	L	L	Н	Н	L						

Pin Functions

Pin No.	Pin Name	Pin Functions				
1	OUT1	H bridge output pin				
2	OUT2	H bridge output pin				
3	OUT3	H bridge output pin				
4	OUT4	H bridge output pin				
5	V _{CC}	Power supply pin				
6	BIAS	Position sensor power pin				
7	COMP	Comparator output pin				
8	INM	Comparator input pin				
9	IN2	Input pin for controlling outputs OUT3 and OUT4				
10	IN1	Input pin for controlling outputs OUT1 and OUT2				
11	ENA	Enable pin (H input: active, L input: idle)				
12	GND	Ground pin				

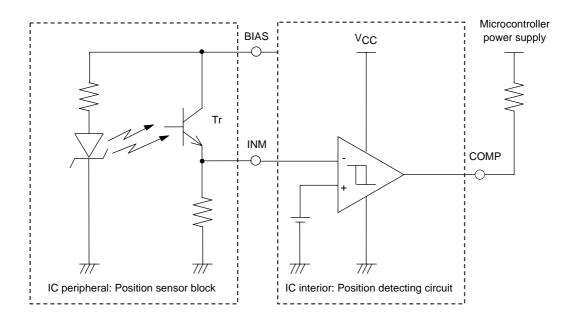
Timing Chart



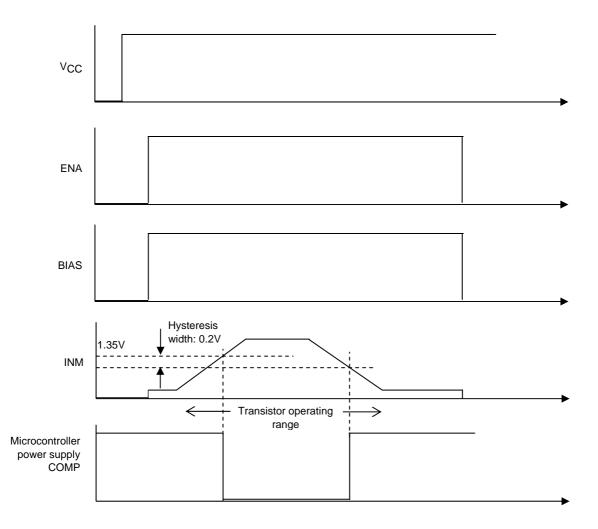
[Timing Chart for Stepping Motor 2-Phase Excitation]

Position Detecting Comparator Application Circuit Example 1

a) Circuit diagram

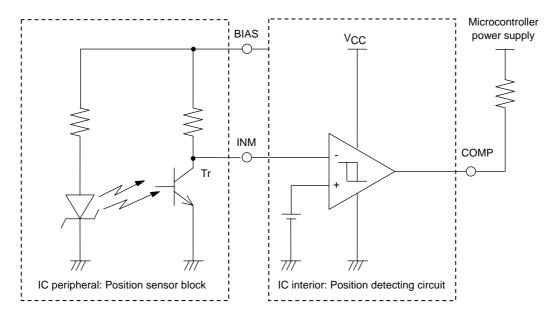


b) Timing chart

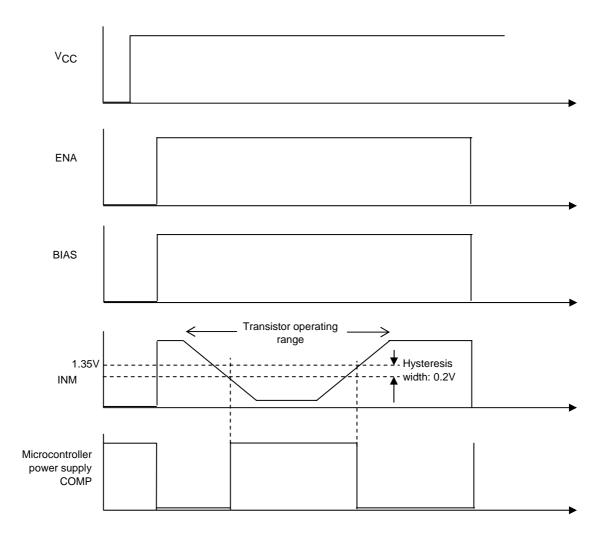


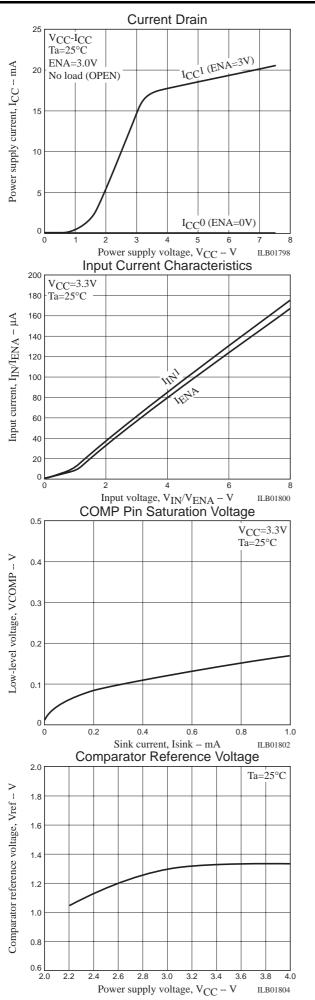
Position Detecting Comparator Application Circuit Example 2

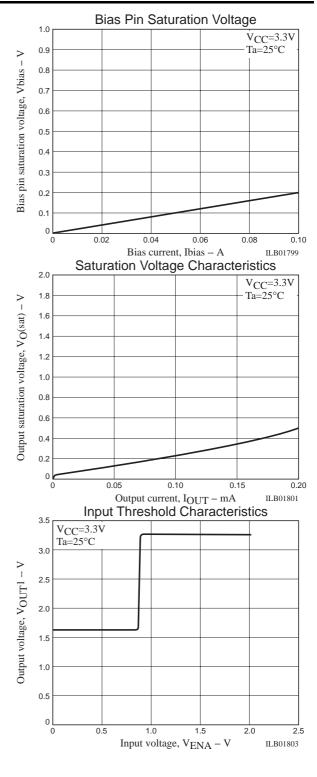
a) Circuit diagram



b) Timing chart







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